

Maximum Ratings @ $T_A = 25^\circ\text{C}$ unless otherwise specified

Characteristic	Symbol	Value	Units
Collector-Base Voltage	V_{CBO}	25	V
Collector-Emitter Voltage	V_{CEO}	20	V
Emitter-Base Voltage	V_{EBO}	5.0	V
Continuous Collector Current	I_C	1.0	A

Thermal Characteristics @ $T_A = 25^\circ\text{C}$ unless otherwise specified

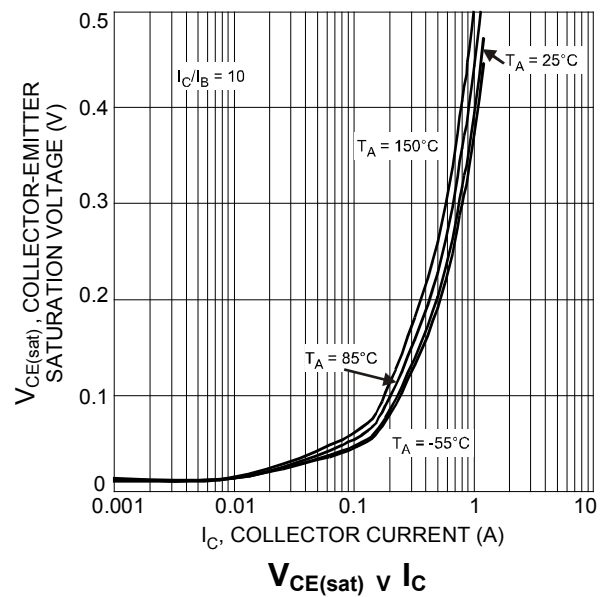
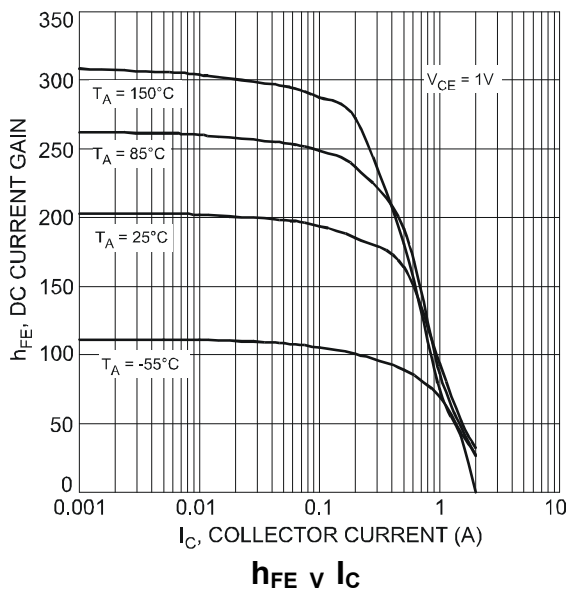
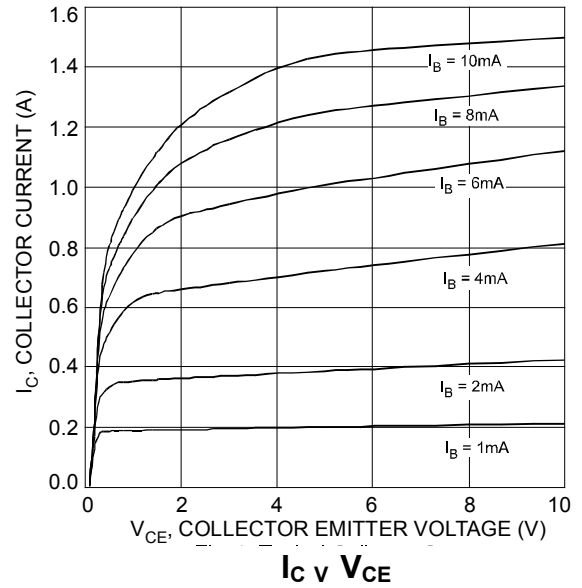
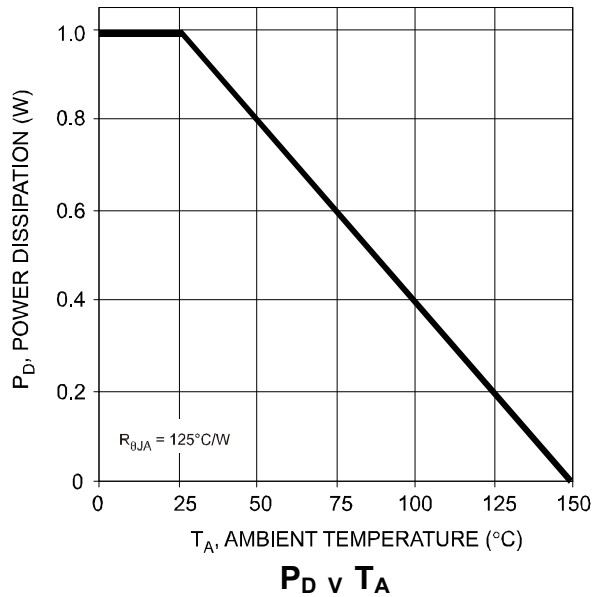
Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	P_D	1	W
Thermal Resistance, Junction to Ambient Air (Note 5)	$R_{\theta JA}$	125	$^\circ\text{C/W}$
Operating and Storage Temperature Range	T_J, T_{STG}	-55 to 150	$^\circ\text{C}$

Electrical Characteristics @ $T_A = 25^\circ\text{C}$ unless otherwise specified

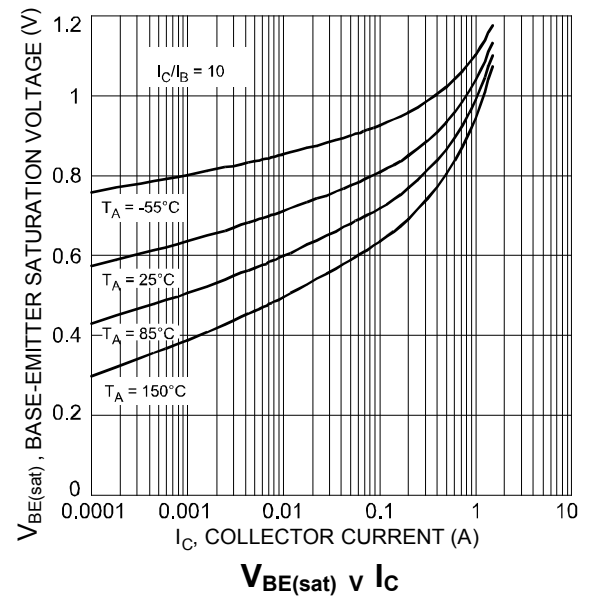
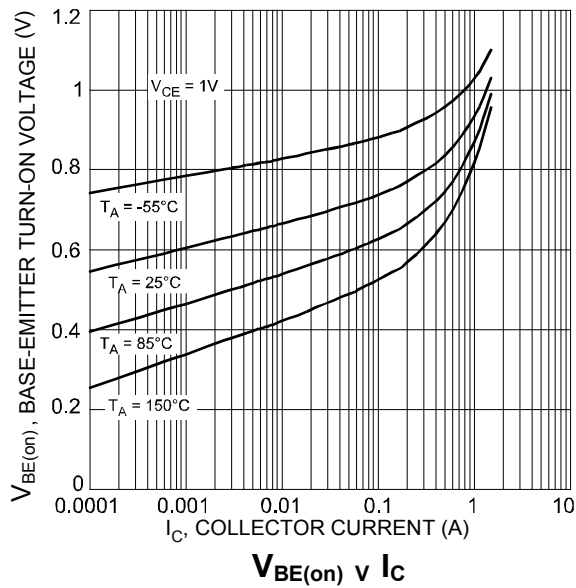
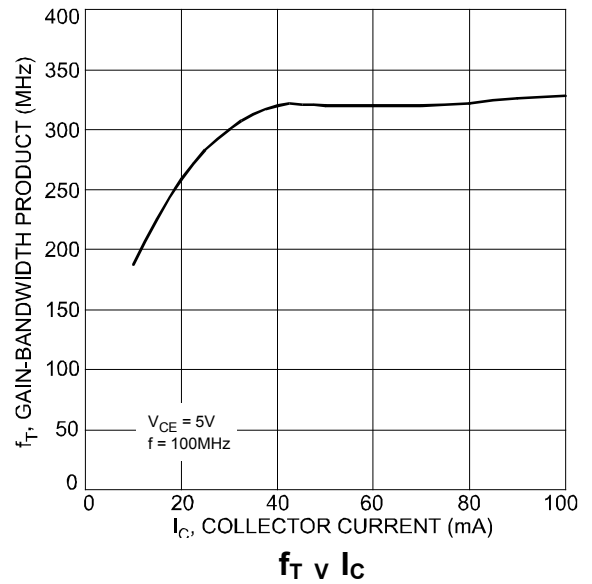
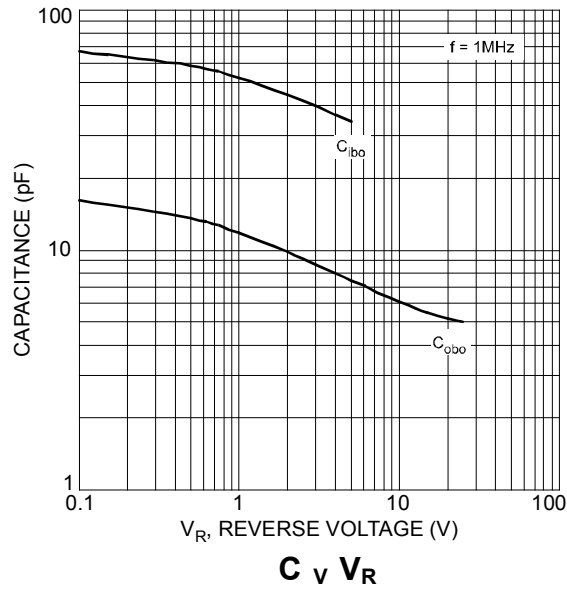
Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 6)						
Collector-Emitter Breakdown Voltage	BV_{CES}	25	—	—	V	$I_C = 100\mu\text{A}, I_E = 0$
Collector-Emitter Breakdown Voltage	BV_{CEO}	20	—	—	V	$I_C = 1.0\text{mA}, I_B = 0$
Collector-Base Breakdown Voltage	BV_{CBO}	25	—	—	V	$I_C = 10\mu\text{A}, I_E = 0$
Emitter-Base Breakdown Voltage	BV_{EBO}	5.0	—	—	V	$I_E = 10\mu\text{A}, I_C = 0$
Collector-Base Cut-Off Current	I_{CBO}	—	—	100	nA	$V_{CB} = 25\text{V}, I_E = 0$
Emitter-Base Cut-Off Current	I_{EBO}	—	—	10	μA	$V_{EB} = 5.0\text{V}, I_C = 0$
ON CHARACTERISTICS (Note 6)						
DC Current Gain	DCP68, DCP68-25	h_{FE}	50	—	—	— $V_{CE} = 10\text{V}, I_C = 5.0\text{mA}$ $V_{CE} = 1.0\text{V}, I_C = 1.0\text{A}$ $V_{CE} = 1.0\text{V}, I_C = 500\text{mA}$ $V_{CE} = 1.0\text{V}, I_C = 500\text{mA}$
	DCP68		60	—	—	
	DCP68-25		85	—	375	
	DCP68-25		160	—	375	
Collector-Emitter Saturation Voltage	$V_{CE(sat)}$	—	—	0.5	V	$I_C = 1.0\text{A}, I_B = 100\text{mA}$
Base-Emitter Turn-On Voltage	$V_{BE(on)}$	—	—	1.0	V	$V_{CE} = 1.0\text{V}, I_C = 1.0\text{A}$
SMALL SIGNAL CHARACTERISTICS						
Transition frequency	f_T	—	330	—	MHz	$I_C = 100\text{mA}, V_{CE} = 5.0\text{V}$ $f = 100\text{MHz}$

Notes: 5. For a device mounted on minimum recommended pad layout 1oz weight copper that is on a single-sided FR4 PCB; device is measured under still air conditions whilst operating in a steady-state.
6. Measured under pulsed conditions. Pulse width $\leq 300\mu\text{s}$. Duty cycle $\leq 2\%$.

Typical Electrical Characteristics (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)



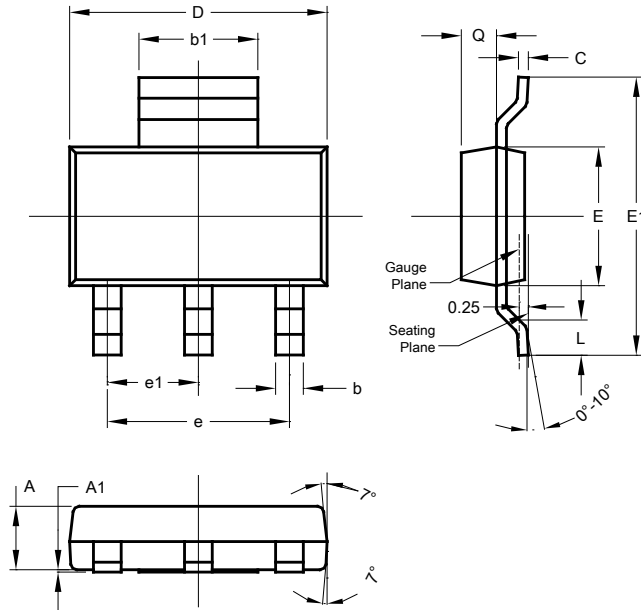
Typical Electrical Characteristics (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)



Package Outline Dimensions

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

SOT223

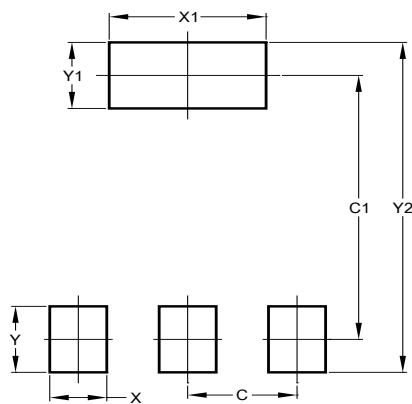


SOT223			
Dim	Min	Max	Typ
A	1.55	1.65	1.60
A1	0.010	0.15	0.05
b	0.60	0.80	0.70
b1	2.90	3.10	3.00
C	0.20	0.30	0.25
D	6.45	6.55	6.50
E	3.45	3.55	3.50
E1	6.90	7.10	7.00
e	—	—	4.60
e1	—	—	2.30
L	0.85	1.05	0.95
Q	0.84	0.94	0.89
All Dimensions in mm			

Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

SOT223



Dimensions	Value (in mm)
C	2.30
C1	6.40
X	1.20
X1	3.30
Y	1.60
Y1	1.60
Y2	8.00

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